

### ZSSC4161D-01

Automotive Resistive Sensor Signal Conditioner with I2C Output

### **Description**

The ZSSC4161D-01 is a member of Renesas' family of CMOS integrated circuits for highly accurate amplification and sensor-specific correction of differential bridge sensor element signals. Featuring a maximum analog pre-amplification up to 200, the ZSSC4161D-01 is configurable to nearly all resistive bridges. This datasheet specifies the specific configuration 4161\_0500\_01.

Digital compensation of offset, sensitivity, temperature drift, and nonlinearity are accomplished via a 16-bit RISC microcontroller. Calibration coefficients and configuration data are stored in the ZSSC4161D-01 nonvolatile memory (NVM), which is reliable in automotive applications.

ZSSC4161D-01 supports use of an external diode or internal PTAT as a temperature reference.

Measured values are provided via a digital I2C interface. The I2C interface enables transmission of sensor data according to the standard interface description. End-of-line calibration is also supported through this interface. The ZSSC4161D-01 and the calibration equipment communicate digitally, so the noise sen-sitivity is greatly reduced. Digital calibration helps keep assembly costs low as no trimming by external devices or lasers is needed.

The ZSSC4161D-01 is optimized for automotive environments by overvoltage and reverse polarity protection circuitry, excellent electromagnetic compatibility, and multiple diagnostic features.

### **Typical Applications**

- Fluid brake pressure sensing (PV)
- Hydraulic pressure sensing (e.g., steering systems with hydraulic steering support)
- Pneumatic pressure sensing (e.g., air brake systems; pneumatic shock absorbers)

#### **Features**

- One differential full bridge sensor element measurement
- · One internal chip temperature measurement
- Digital compensation for offset, gain, and higher order nonlinearity as well as temperature coefficients of the differential and half bridge sensor element input signal
- Operating temperature range: -40°C to +150°C
- Accuracy as high as ±0.50% full scale at -40°C to +150°C
- NVM memory for configuration, calibration data, and configurable measurement and conditioning functionality
- One-pass, end-of-line calibration algorithm minimizes production costs
- I2C interface for programming, calibration, and data output
- Internal pull-ups to VDDE at the SDA and SCL pins eliminate the need for extra external components.
- Alternative ZACwire<sup>™</sup> one-wire interface (OWI) on DOUT pin available for programming/calibration/faultcommunication
- · No external trimming or components required
- · Qualified according to AEC-Q100 Grade 0

### **Physical Characteristics**

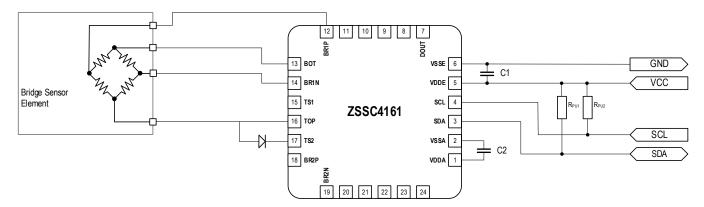
- Supply voltage: 4.5V to 5.5V
- Over-voltage and reverse polarity protection up to ±18V
- Bridge sensor element input span: 1mV/V to 800mV/V
- · Output resolution: 15-bit via I2C interface
- Package: 24-QFN (4 x 4 mm; wettable flanks) or bare die

### **Available Support**

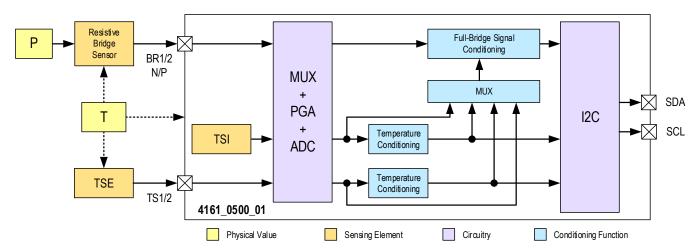
- Evaluation Kit
- Application Notes
- · Calculation Tools

ZSSC4161D-01 Short-Form Datasheet

# **Basic Circuit**



# **Signal Path**



# **Ordering Information**

Part Number	Description and Package	MSL Rating	Carrier Type	Temperature
ZSSC4161DE1B	Single bridge input, I2C output, internal and/or external temperature measurement, tested wafer	na	Wafer Boxes	-40°C to +150°C
ZSSC4161DE1C	Single bridge input, I2C output, internal and/or external temperature measurement, tested die sawn on frame	na	Frame Boxes	-40°C to +150°C
ZSSC4161DE1D-ES	Single bridge input, I2C output, internal and/or external temperature measurement, tested die in waffle pack	na	Waffle Pack	-40°C to +150°C
ZSSC4161DE4R	One bridge input, I2C output, internal and/or external temperature measurement, $4\times 4$ mm 24-QFN, wettable flanks	MSL1	13" Reel	-40°C to +150°C
ZSSC4161DE4W	One bridge input, I2C output, internal and/or external temperature measurement, 4 × 4 mm 24-QFN, wettable flanks	MSL1	7" Reel	-40°C to +150°C

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